





### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = 25°C		
601/	68mΩ @ V <sub>GS</sub> = 10V	5.6A		
60V	100mΩ @ V <sub>GS</sub> = 4.5V	4.7A		

## **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor control
- · Transformer driving switch
- DC-DC Converters
- Power management functions
- Uninterrupted power supply

### **Features and Benefits**

- 100% Unclamped Inductive Switch (UIS) test in production
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

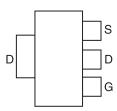
### **Mechanical Data**

- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish Matte Tin annealed over Copper lead frame.
   Solderable per MIL-STD-202, Method 208
- Weight: 0.112 grams (approximate)

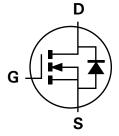
#### SOT223



Top View



Pin Out - Top View



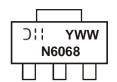
**Equivalent Circuit** 

### Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMN6068SE-13	N6068	13	12	4,000	

Notes: 1. Diodes, Inc. defines "Green" products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

## **Marking Information**



Oll = Manufacturer's Marking N6068 = Product Type Marking Code YWW = Date Code Marking Y = Year (ex: 9 = 2009) WW = Week (01 - 53)





# **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

	Characteristic		Symbol	Value	Unit	
Drain-Source voltage			$V_{DSS}$	60	V	
Gate-Source voltage (Note 2)			V <sub>GS</sub>	±20	V	
Single Pulsed Avalanche Energy (Note 7)		(Note 7)	E <sub>AS</sub>	37.5	mJ	
Single Pulsed Avalanche Current		(Note 7)	I <sub>AS</sub>	5.0	Α	
Continuous Drain current		(Note 4)	ID	5.6		
	$V_{GS} = 10V$	$T_A = 70^{\circ}C$ (Note 4)		4.5	Α	
		(Note 3)		4.1		
ulsed Drain current V <sub>GS</sub> = 10V (Note 5)		(Note 5)	I <sub>DM</sub>	20.8	Α	
Continuous Source current (Body diode)		(Note 4)	I <sub>S</sub>	4.9	А	
Pulsed Source current (Body diode)		(Note 5)	I <sub>SM</sub>	20.8	А	

### Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Power dissipation	(Note 3)	0	2.0 16.0	W	
Linear derating factor	(Note 4)	P <sub>D</sub>	3.7 29.5	mW/°C	
Thermal Begintance, Junction to Ambient	(Note 3)	Б.	62.5		
Thermal Resistance, Junction to Ambient	(Note 4)	$R_{\theta JA}$	34	°C/W	
Thermal Resistance, Junction to Lead	(Note 6)	$R_{ heta JL}$	11.5		
Operating and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

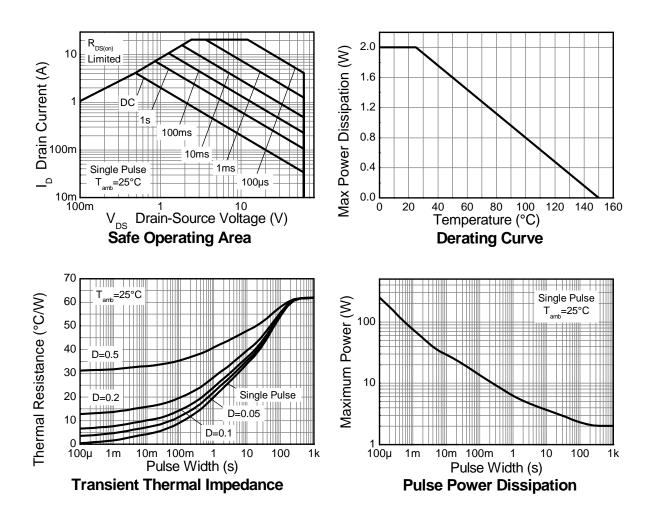
### Notes:

- 2. AEC-Q101  $V_{GS}$  maximum is  $\pm 16V$ .
- 3. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 4. Same as note (3), except the device is measured at t ≤ 10 sec.
  5. Same as note (3), except the device is pulsed with D= 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
  6. Thermal resistance from junction to solder-point (at the end of the drain lead).
  7. UIS in production with L = 3.0mH, I<sub>AS</sub> = 5.0A, R<sub>G</sub> = 25Ω, V<sub>DD</sub>=50V, starting T<sub>J</sub> = 25°C.





## **Thermal Characteristics**







# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Co	ondition	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	$BV_{DSS}$	60	_	_	V	$I_D = 250 \mu A, V_{GS} =$	= 0V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	0.5	μΑ	$V_{DS}$ = 60V, $V_{GS}$ =	0V	
Gate-Source Leakage	IGSS	_	_	±100	nA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> :	= 0V	
ON CHARACTERISTICS								
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0		3.0	V	I <sub>D</sub> = 250μA, V <sub>DS</sub> =	: V <sub>GS</sub>	
Ctatia Dania Causas On Beniatanas (Nata 9)	,			0.068	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12	2A	
Static Drain-Source On-Resistance (Note 8)	R <sub>DS</sub> (ON)	_	_	0.100	12	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6	5A	
Forward Transconductance (Notes 8 & 9)	9 <sub>fs</sub>	_	19.7	_	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 12	2A	
Diode Forward Voltage (Note 8)	$V_{SD}$	_	0.98	1.15	V	I <sub>S</sub> = 12A, V <sub>GS</sub> = 0	V	
Reverse recovery time (Note 9)	t <sub>rr</sub>		145	_	ns	I <sub>S</sub> = 12A, di/dt= 100A/μs		
Reverse recovery charge (Note 9)	Q <sub>rr</sub>	_	929	_	nC			
DYNAMIC CHARACTERISTICS (Note 9)	, , ,							
Input Capacitance	C <sub>iss</sub>	_	502		pF			
Output Capacitance	Coss	_	45.7	_	рF	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V f= 1MHz		
Reverse Transfer Capacitance	Crss	_	27.1	_	pF			
Total Gate Charge (Note 10)	$Q_g$	_	5.55	_	nC	V <sub>GS</sub> = 4.5V		
Total Gate Charge (Note 10)	Qg	_	10.3	_	nC		V <sub>DS</sub> = 30V	
Gate-Source Charge (Note 10)	Q <sub>gs</sub>	_	1.6	_	nC	V <sub>GS</sub> = 10V	I <sub>D</sub> = 12A	
Gate-Drain Charge(Note 10)	$Q_{gd}$	_	3.5	_	nC	1		
Turn-On Delay Time (Note 10)	t <sub>D(on)</sub>	_	3.6	_	ns			
Turn-On Rise Time (Note 10)	t <sub>r</sub>	_	10.8		ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V		
Turn-Off Delay Time (Note 10)	t <sub>D(off)</sub>	_	11.9	_	ns	I <sub>D</sub> = 12A, R <sub>G</sub> ≅ 6.0Ω		
Turn-Off Fall Time (Note 10)	t <sub>f</sub>	_	8.7		ns			

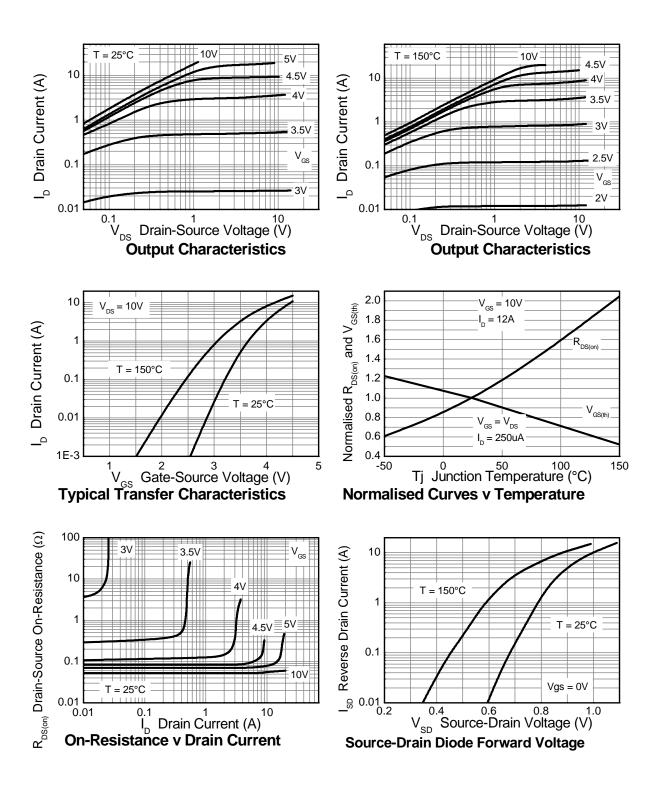
Notes:

<sup>8.</sup> Measured under pulsed conditions. Pulse width  $\le 300 \mu s$ ; duty cycle  $\le 2\%$ 9. For design aid only, not subject to production testing.
10. Switching characteristics are independent of operating junction temperatures.





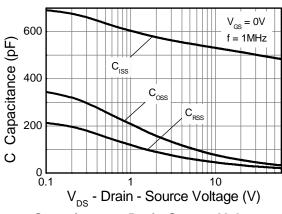
# **Typical Characteristics**



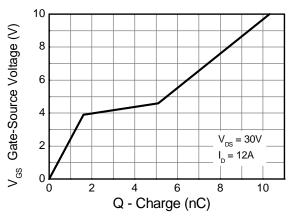




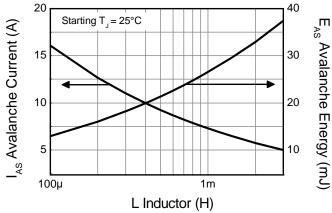
# **Typical Characteristics - continued**



Capacitance v Drain-Source Voltage



Gate-Source Voltage v Gate Charge

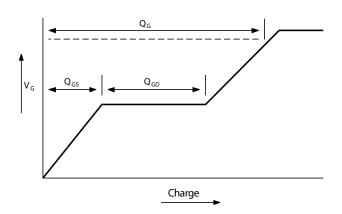


Single-Pulsed Avalanche Rating

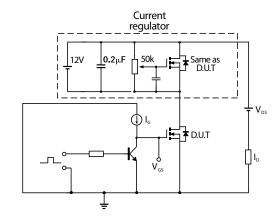




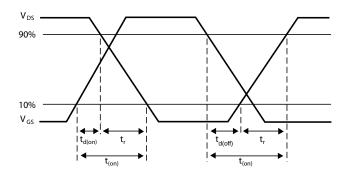
# **Test Circuits**



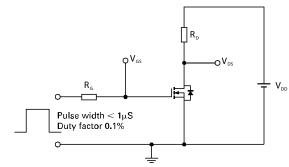
Basic gate charge waveform



Gate charge test circuit



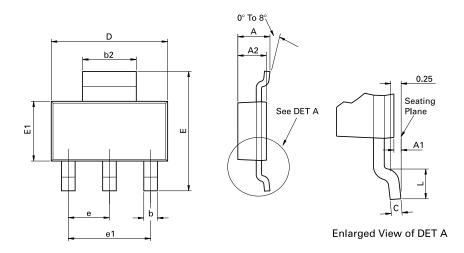
Switching time waveforms



Switching time test circuit



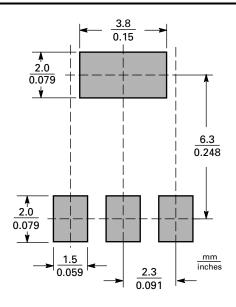
# **Package Outline Dimensions**



Conforms to JEDEC TO-261 AA Issue B

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
DIM	Min	Max	Min	Max	DIM	Min	Max	Min	Max
Α	-	1.80	-	0.071	D	6.30	6.70	0.248	0.264
A1	0.02	0.10	0.0008	0.004	е	2.30 BSC		0.0905 BSC	
A2	1.55	1.65	0.0610	0.0649	e1	4.60 BSC		0.181 BSC	
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
С	0.23	0.33	0.009	0.013	L	0.90	-	0.355	-

# **Suggested Pad Layout**







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